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Product Change Notification - IIRA-08LIDK202 (Printer Friendly)

**Date:** 07 Oct 2014

Notification subject: CCB 1336.02 Final Notice: Qualification of 8600 die attach and G700LTD mold compound for 8L DFN-S (6x5x0.9mm) and 8L DFN

(3x3x0.9mm) packages at NSEB (UTL) assembly site.

Notification text: PCN Status:

Final notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

PCN\_IIRA-08LIDK202\_Affected\_CPN.xls PCN\_IIRA-08LIDK202\_Affected\_CPN.pdf

**Description of Change:** 

Qualification of 8600 die attach and G700LTD mold compound for 8L DFN-S (6x5x0.9mm) and 8L DFN (3x3x0.9mm) packages at

NSEB (UTL) assembly site.

Impacts to Data Sheet:

None

Reason for Change:

To improve on-time delivery performance by qualifying additional mold compound and die attach materials.

Change Implementation Status:

Complete

**Estimated First Ship Date:** 

November 3, 2014 (date code: 1445)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

**Revision History:** 

May 21, 2014: Issued initial notification.

October 7, 2014: Issued final notification. Attached the Qualification Report. Revised the estimated first ship date from August 17,

2014 to November 3, 2014.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the

applicable products.

Attachment(s): PCN\_IIRA-08LIDK202\_Qual Report.pdf

PCN\_IIRA-08LIDK202\_Affected CPN.pdf PCN\_IIRA-08LIDK202\_Affected CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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